SFH 4545

Radial T1 3/4

High Power Infrared Emitter (940 nm)







Applications

- Electronic Equipment
- Industrial Automation (Machine Controls, Light Barriers, Vision Controls)
- Safety and Security, CCTV
- Smoke Detectors

Features:

- Package: black epoxy
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- High Power Infrared LED
- Short switching times

Ordering Information

Туре	Radiant intensity 1)	Radiant intensity 1) typ.	Ordering Code
	$I_{\rm F}$ = 100 mA; $t_{\rm p}$ = 20 ms $I_{\rm e}$	$I_{\rm F}$ = 100 mA; $t_{\rm p}$ = 20 ms $I_{\rm e}$	
SFH 4545	250 1250 mW/sr	550 mW/sr	Q65110A8095
SFH 4545-DWEW	400 1250 mW/sr	550 mW/sr	Q65111A3701



Ma	xim	ıım	Ra	tina	25
ivia	AIIII	ulli	Na	UHI	4 5

T,	=	25	$^{\circ}C$
٠,		20	\sim

Parameter	Symbol		Values
Operating temperature	T _{op}	min. max.	-40 °C 100 °C
Storage temperature	T_{stg}	min. max.	-40 °C 100 °C
Forward current	I _F	max.	100 mA
Surge current $t_p \le 100 \mu s; D = 0$	I _{FSM}	max.	1 A
Reverse voltage ²⁾	V_R	max.	12 V
Power consumption	P _{tot}	max.	180 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max.	2 kV



Characteristics

 $I_{_{\rm F}}$ = 100 mA; $t_{_{
m p}}$ = 20 ms; $T_{_{
m A}}$ = 25 °C

Parameter	Symbol		Values
Peak wavelength	λ_{peak}	typ.	950 nm
Centroid wavelength 3)	λ _{centroid}	min. typ. max.	920 nm 940 nm 960 nm
Spectral bandwidth at 50% I _{rel,max}	Δλ	typ.	42 nm
Half angle	φ	typ.	5 °
Dimensions of active chip area	LxW	typ.	0.3 x 0.3 mm x mm
Rise time (10% / 90%) $I_F = 100 \text{ mA}; R_L = 50 \Omega$	t _r	typ.	12 ns
Fall time (10% / 90%) $I_F = 100 \text{ mA}; R_L = 50 \Omega$	t _f	typ.	12 ns
Forward voltage	V_{F}	typ. max.	1.5 V 1.8 V
Forward voltage $I_F = 1 \text{ A}; t_p = 100 \mu\text{s}$	V_{F}	typ. max.	2.3 V 3 V
Reverse current ²⁾ V _R = 5 V	I _R	max. typ.	10 μA 0.01 μA
Radiant intensity ¹⁾ $I_F = 1 \text{ A}; t_p = 25 \mu \text{s}$	l _e	typ.	4200 mW/sr
Total radiant flux 4)	Фе	typ.	55 mW
Temperature coefficient of voltage	TC_{v}	typ.	-1.3 mV / K
Temperature coefficient of brightness	TC,	typ.	-0.5 % / K
Temperature coefficient of wavelength	$TC_{_{\lambda}}$	typ.	0.3 nm / K
Thermal resistance junction ambient real 5)	R_{thJA}	max.	450 K / W



Brightness Groups

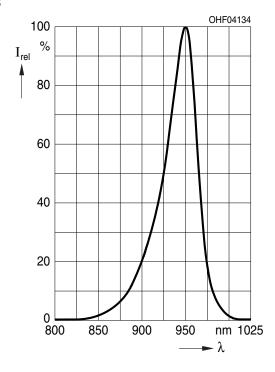
 $T_A = 25$ °C

Group	Radiant intensity $I_F = 100 \text{ mA}$; $t_p = 20 \text{ ms}$ min. I_e	Radiant intensity $I_F = 100 \text{ mA}$; $t_p = 20 \text{ ms}$ max. I_e
CW	250 mW/sr	500 mW/sr
DW	400 mW/sr	800 mW/sr
EW	630 mW/sr	1250 mW/sr

Only one group in one packing unit (variation lower 2:1).

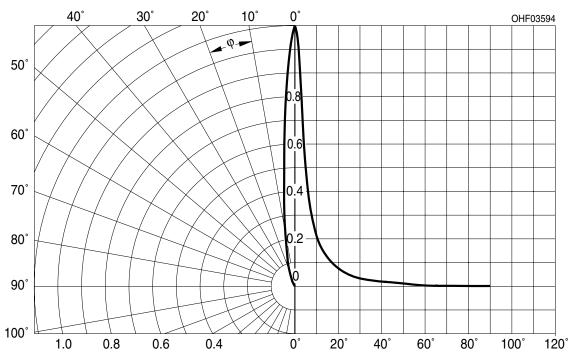
Relative Spectral Emission 6), 7)

$$I_{rel} = f(\lambda); I_{F} = 100 \text{ mA}; t_{p} = 20 \text{ ms}$$



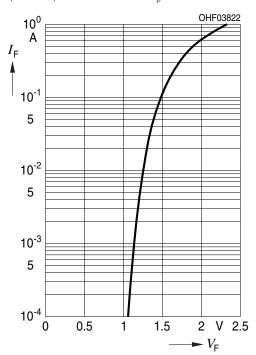
Radiation Characteristics 6), 7)





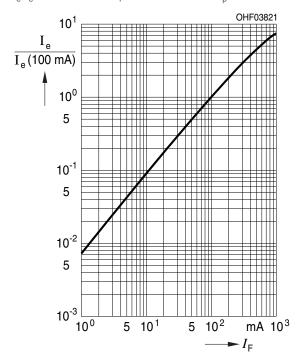
Forward current 6), 7)

 $I_F = f(V_F)$; single pulse; $t_p = 100 \mu s$



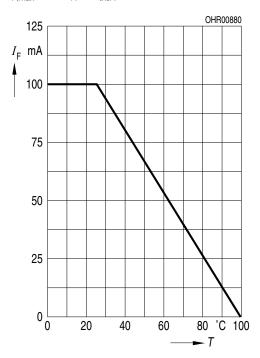
Radiant Intensity 6), 7)

 I_e/I_e (100mA) = f (I_F); single pulse; t_p = 25 μs



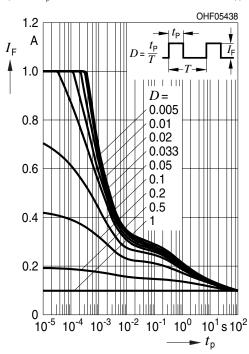
Max. Permissible Forward Current

$$I_{F,max} = f(T_A); R_{thJA} = 450 K/W$$



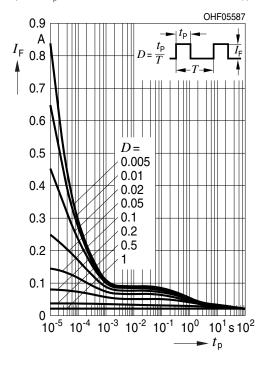
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; duty cycle D = parameter; $T_A = 25$ °C

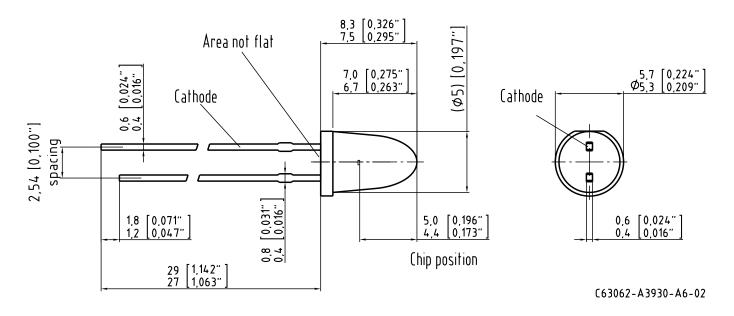


Permissible Pulse Handling Capability

 $I_F = f(t_p)$; duty cycle D = parameter; $T_A = 85$ °C



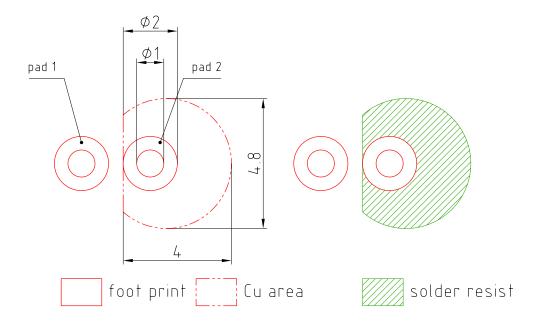
Dimensional Drawing 8)



Approximate Weight: 298.0 mg

Package marking: Cathode

Recommended Solder Pad 8)

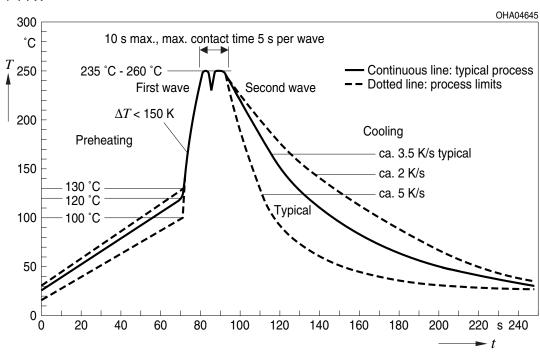


E062.3010.188-01

Pad 1: cathode

TTW Soldering

IEC-61760-1 TTW





Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

Packing information is available on the internet (online product catalog).

For further application related informations please visit www.osram-os.com/appnotes



Disclaimer

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the OSRAM OS Webside.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

In case Buyer - or Customer supplied by Buyer- considers using OSRAM OS components in product safety devices/applications or medical devices/applications, Buyer and/or Customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and Buyer and /or Customer will analyze and coordinate the customer-specific request between OSRAM OS and Buyer and/or Customer.



Glossary

- Radiant intensity: Measured at a solid angle of $\Omega = 0.001 \text{ sr}$
- ²⁾ **Reverse Operation**: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Dimensions of active chip area: The active chip area consists of 10 single chips with 1 x 1 mm each.
- ⁴⁾ **Total radiant flux**: Measured with integrating sphere.
- Thermal resistance: junction ambient, mounted on PC-board (FR4), padsize 16 mm² each
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Testing temperature: $T_{\Delta} = 25^{\circ}C$
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.



Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product Leibnizstraße 4, D-93055 Regensburg www.osram-os.com © All Rights Reserved.

此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准,不含有毒有害物质或元素。

